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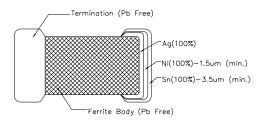
The Pulse Electronics $0402 \sim 1806$ series ranges of Miniature Ferrite beads contains the very latest in multi layer ferrite beads technology, thus providing the ultimate in performance demanded by today's high Speed EMI noise filtering products. The ferrite beads are in an industry standard size and footprint.

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Ferr	ite Bead EMI Suppressor		
	Single Type - 0402FB, 0603FB & 0805FB Series	9-1	0
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1.0 Ferrite Beads

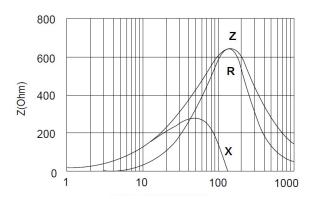
It is known as absorptive beads, is more lossy and make good power filter networks because they are designed to absorb high-frequency noise currents and dissipate it as heat. These beads have high impedance over wide high-frequency bands, making them ideal as low-pass noise filters.

Structure



Equivalent Circuit





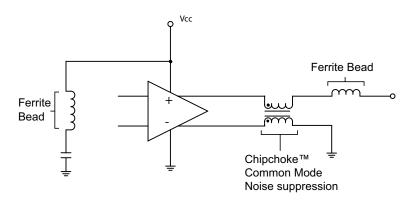
FREQUENCY (MHz)

Z = Impedance (ohm)

R = Real Part (resistance)

X = imaginary Part (inductance)

Application



2.0 Parts Number Legend

PE-0201	FB	121	S	T	A
PACKAGE STYLE	CORE MATERIAL	Impedance (Ω)	TOLERANCE *	PACKAGE	Enhanced
0402, 0603,	FB = Ferrite Bead	121=120 Ω	J = ±5%	T = Tape & Reel	A = Alternative
0805, 1206	HFB = High Frequency Ferrite Bead		S = ±25%		
1806	PFB = High Current Ferrite Bead		X = not apply		

^{*} There is no tolerance option for these products.



3.0 Competitor Cross

ITEM	Pulse	TAIYO YUDEN	TDK	MURATA
Ferrite Bead Single	FB Series	BK & FBM Series	MMZ Series	BLMxxAG Series
				BLMxxBD Series
				BLMxxAX Series
GHz Ferrite Beads Single	HFB Series	FBMH Series	MMZ1005-E Series	BLMxxH Series
Power Ferrite Bead Single	PFB Series			BLMxxPG Series

4.0 Reliability and Test Condition

Item	Performance	Test Condition		
Series No.	PE-0402FB/0603FB/0805FB/0402HFB/0603HFB/			
Operating	-40 ~+105°C			
Temperature	(Including self-temperature rise)			
Transportation	-40 ~+125°C			
Storage				
Temperature				
Impedance (Z)	Refer to standard electrical characteristics list	Agilent4291		
Inductance (Ls)		AgilentE4991		
Q Factor		Agilent4287		
DC Resistance		Agilent16192		
Rated Current		Agilent4338		
		DC Power Supply		
		Over Rated Current requirements		
Temperature Rise	Rated Current < 1A △T 20 °C Max	1. Applied the allowed DC current		
Test	Rated Current ≥ 1A ∆T 20°C Max	2. Temperature measured by digital surface thermometer		
Resistance to	Appearance: No damage	Preheat: 150°C, 60sec		
Soldering Heat	Impedance: Within ±15% of initial value	Solder: Sn99.5%-Cu0.5%		
	Inductance: Within ±10% of initial value	Solder temperature: 260±5°C		
	Q: Shall not exceed the specification value.	Flux for lead free: Rosin.9.5%		
	RDC: Shall not exceed the specification value.	Temperature ramp/immersion and immersion rate: 25±6 mm/s		
	Preheating Dipping Natural Cooling	Dip time: 10±1sec.		
260°C		Depth: completely cover the termination.		
	150°C 10±1.0			
	60 second second			

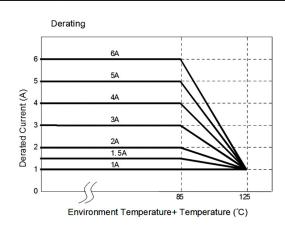
4.0 Reliability and Test Condition

Item	Performance	Test Condition			
Solderability	More than 95% of the terminal electrode should be covered with solder	Preheat: 150°C, 60sec			
	Put of a Profes Not at Out for	Solder: Sn99.5%-Cu0.5%			
	Preheating Dipping Natural Cooling	Solder temperature: 245±5°C			
	2430	Flux for lead free: Rosin.9.5%			
	150°C 4+1 0	Depth: completely cover the termination.			
	150°C 4±1.0 second	Dip time: 4±1sec.			
Terminal strength	Appearance: No damage.	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC			
-	Impedance: within±15% of initial value	J-STD-020E Classification Reflow Profiles)			
	Inductance: within±10% of initial value				
	Q: Shall not exceed the specification value.	Component mounted on a PCB apply a force (>0805:1kg<=080			
		5:0.5kg) to the side of a device being tested. This force shall be			
	RDC: Shall not exceed the specification value.	applied for 60 +1 econds. Also the force shall be applied gradually			
	Radius 0.5mm	as not to shock the component being tested.			
	Press tool				
Danding	Shear force	Chall he may retail an a FDA substrate of the			
Bending	Appearance: No damage.	Shall be mounted on a FR4 substrate of the			
	Impedance: within ±10% of initial value Inductance: within ±10% of initial value	Following dimensions: >=0805:40x100x1.2mm			
		<0805:40x100x0.8mm			
	Q: Shall not exceed the specification value RDC: Shall not exceed the specification value	Bending depth: >=0805:1.2mm Duration of 10 sec for a min.			
	RDC. Stidil flot exceed the specification value	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC			
Vibration Test	Appearance: No damage.	J-STD-020E Classification Reflow Profiles)			
	Impedance: within ±15% of initial value	Oscillation Frequency: 10 2K 10Hz for 20 minutes			
	Inductance: within ±10% of initial value	Equipment: Vibration checker			
	Q: Shall not exceed the specification value	Total Amplitude: 1.52mm ±10%			
	RDC: within ±15% of initial value and shall not exceed the specification	Testing Time: 12 hours (20 minutes 12 cycles each of 3 orientations).			
	value				
Shock	Appearance: No damage.	Test condition:			
	Impedance: within ±15% of initial value	Type Peak Normal Velocity			
	Inductance: within ±10% of initial value	Value duration _{Wave} change			
	Q: Shall not exceed the specification value	(g's) (D) (ms) form (Vi)ft/sec			
	RDC: within ±15% of initial value and shall not exceed the	SMD 1,500 0.5 Half-sine 15.4			
	specification value	Lead 100 6 Half-sine 12.3			

Life Test	Appearance: No damage.	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC
	Impedance: within ±15% of initial value	J-STD-020E Classification Reflow Profiles)
	Inductance: within ±10% of initial value	Temperature: 125±2°C(bead),
	Q: Shall not exceed the specification value	85±2°C(inductor)
	RDC: within $\pm 15\%$ of initial value and shall not exceed the	Applied current: rated current
	specification value	Duration: 1000±12hrs. Measured at room temperature after placing for 24±2 hrs.
Load Humidity		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020E Classification Reflow Profiles)
		Humidity: 85±2%R.H.
		Temperature: 85±2°C
		Duration: 1000hrs Min. with 100% rated current.
		Measured at room temperature after placing for 24±2 hrs.
Thermal Shock	Appearance: no damage	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC
	Impedance: within ±15% of initial value	J-STD-020E Classification Reflow Profiles)
	Inductance: within $\pm 10\%$ of initial value	Condition for 1 cycle
	Q: Shall not exceed the specification value	Step1: -40±2°C 30±5 min.
	RDC: Shall not exceed the specification value	Step2: 25±2°C≤30±0.5 min.
		Step3: +105±2°C 30±5 min.
		Number of cycles: 500
		Measured at room temperature after placing for 24±2 hrs.
Insulation	IR>1GΩ	Chip Inductor Only
Resistance		Test Voltage: 100±10%V for 30Sec

5. **Derating Curve

For the ferrite chip bead which withstanding current over 1.5A, as operating temperature over 85°C, the derating current information is necessary to consider. For the detail derating of current, please refer to the Derated Current vs. perating Temperature curve.



6. Soldering

Mildly activated rosin fluxes are preferred. The termination are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools. Note. If wave soldering is used, there will be some risk. Re-flow soldering temperatures below 240 degrees, there will be non-wetting risk.

6.1 Lead Free Solder re-flow

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Reflow times: 3 times max

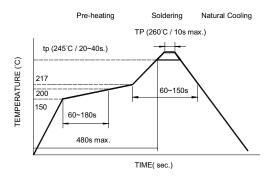


Figure 1

6.2 Solder Iron

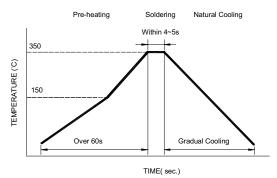


Figure 2 (1 time max)

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. If a soldering iron must be employed the following precautions are recommended. For Iron Soldering in Figure 2.

- Preheat circuit and products to 150°C
- 350°C tip temperature (max)
- Never contact the ceramic with the iron flip
- 1.00mm tip diameter (max)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limited soldering time to 4~5sec

6.3 Solder Volume

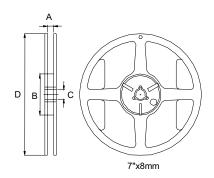
Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance. Solder shall be used not to be exceed as shown in the right side:

Minimum fillet height = soldering thickness + 25% product height



7. Packaging Information

7.1 Reel Dimension



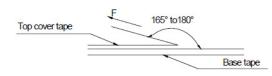


Туре	A(mm)	B(mm)	C(mm)	D(mm)	
7"x8mm	10.0±1.5	50 or more	13±0.2	178 ± 2	

7.2 Qty/reel

Chip Size	Chip/Reel	Reel Diameter
PE-0402HFB	10000	178 x 8mm
PE-0402FB	10000 178 x 8m	
PE-0603FB	4000	178 x 8mm
PE-0603HFB	4000	178 x 8mm
PE-0603PFB	4000	178 x 8mm
PE-0805FB	4000	178 x 8mm
PE-0805PFB	4000	178 x 8mm
PE-1206PFB	3000	178 x 8mm
PE-1806PFB	3000	178 x 8mm

7.3 Tearing Off Force



The force for tearing off cover tape is 15 to 60 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed
(C)	(%)	(hPa)	mm/min
5 ~ 35	45~85	860~1060	300

Application Notice

*Storage Conditions

To maintain the solder ability of terminal electrodes:

- 1. Products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
- 2. Temperature and humidity conditions: Less than 40°C and 60% RH.
- 3. Recommended products should be used within 12 months from the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- * Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.



FERRITE BEAD EMI SUPPRESSOR SINGLE TYPE - FB SERIES FOR GENERAL SIGNAL LINE





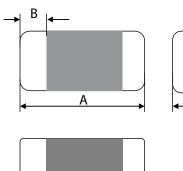
- Signal Line EMI Suppression
- Monolithic inorganic material contstruction
- Warious impedance and frequency application
- ② Industry Standard package

Electrical Specifications @ 25°C										
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$										
PE-0402FB100XT	0~15	-	100	0.03	1000					
PE-0402FB121ST	120	±25%	100	0.2	550					
PE-0402FB601ST	600	±25%	100	0.55	300					
PE-0402FB102ST	1000	±25%	100	0.58	300					
PE-0603FB121ST	120	±25%	100	0.18	500					
PE-0603FB221ST	220	±25%	100	0.25	500					
PE-0603FB601ST	600	±25%	100	0.38	500					
PE-0603FB102ST	1000	±25%	100	0.5	400					
PE-0805FB121ST	120	±25%	100	0.15	800					
PE-0805FB601ST	600	±25%	100	0.3	500					
PE-0805FB102ST	1000	±25%	100	0.4	500					

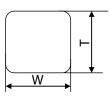
Mechanicals

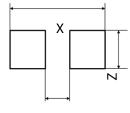
Application

PE-0402/0805FB



Unit: mm





Y SUGGESTED LAND PATTERN

Dimension:

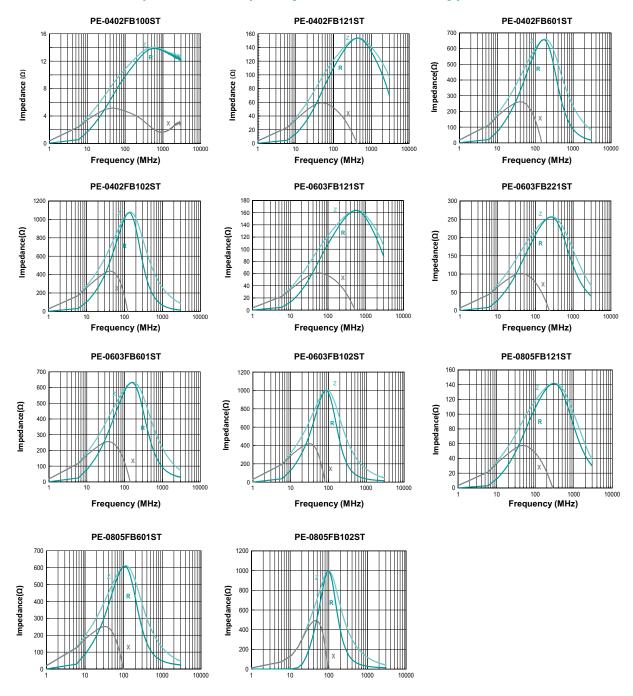
Imperial Size	A	В	W	I	X	Y	Z
0402	1.0±0.15	0.25±0.1	0.5±0.15	0.5±0.15	1.25 ~ 1.55	0.45~0.55	0.4~0.6
0603	1.6±0.15	0.3±0.2	0.8±0.15	0.8±0.15	1.8~2.4	0.6~0.8	0.6~0.8
0805	2.0(+0.3, -0.1)	0.5±0.3	1.25±0.2	0.85±0.2	2.4~3.6	0.8~1.2	0.9~1.6

All units in mm



FERRITE BEAD EMI SUPPRESSOR SINGLE TYPE - FB SERIES FOR GENERAL SIGNAL LINE

Impedance Frequency Characteristics (Typical)



FERRITE BEAD EMI SUPPRESSOR SINGLE TYPE FOR HIGH FREQUENCY APPLICATION



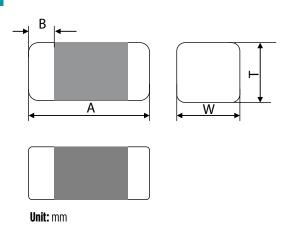


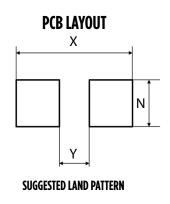
- Signal Line EMI Suppression
- Monolithic inorganic material construction
- Warious impedance and frequency application
- High Frequency Giga Hz Application
- Industry Standard package

Electrical Specifications @ 25°C									
Part Number		Tolerance	Test Frequency (MHz)	Impedance (Ω) 1GHz mini	DC Resistance (Ω) max.	Rated Current (mA) max.			
PE-0402HFB221ST	220	±25%	100	250	0.25	700			
PE-0402HFB601ST	600	±25%	100	840	0.85	300			
PE-0402HFB102ST	1000	±25%	100	1200	1.25	250			
PE-0402HFB102STA	1000	±25%	100	900	1.1	250			
PE-0402HFB152ST	1500	±25%	100	-	1.50	200			
PE-0402HFB182ST	1800	±25%	100	-	2.0	200			
PE-0603HFB601ST	600	±25%	100	450	0.35	500			
PE-0603HFB102ST	1000	±25%	100	750	1.6	100			
		±25%	100	750	1.6	100			

Mechanical

PE-XXXXHFB





Dimension:

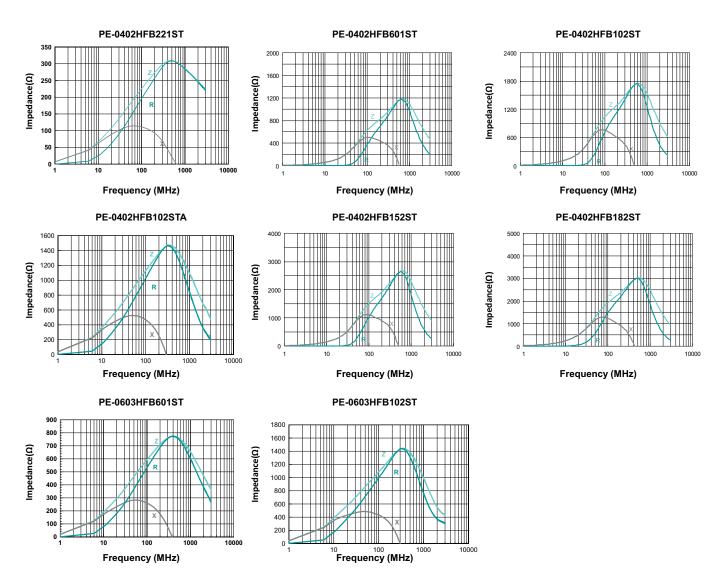
Imperial Size	A	В	W	T	X	Y	Z
0402	1.0±0.15	0.25±0.1	0.5±0.15	0.5±0.15	1.25 ~ 1.55	0.45~0.55	0.45~0.55
0603	1.6±0.15	0.3±0.2	0.8±0.15	0.85±0.2	1.8~2.4	0.6~0.8	0.6~0.8

All units in mm



FERRITE BEAD EMI SUPPRESSOR SINGLE TYPE FOR HIGH FREQUENCY APPLICATION

Impedance Frequency Characteristics (Typical)



FERRITE BEAD EMI SUPPRESSOR SINGLE TYPE FOR POWER LINE APPLICATION



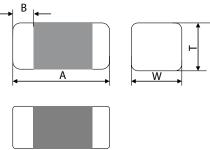


- Power Line EMI Suppression
- @ Monolithic inorganic material construction
- @ Various impedance and frequency application
- Industry Standard package

Electrical Specifications @ 25°C							
Part Number	Impedance (Ω)	Tolerance	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Current (mA) max.		
PE-0603PFB121ST	120	±25%	100	0.05	2000		
PE-0603PFB181ST	180	±25%	100	0.09	1500		
PE-0603PFB221ST	220	±25%	100	0.05	2200		
PE-0603PFB471ST	470	±25%	100	0.2	1000		
PE-0603PFB600ST	60	±25%	100	0.04	3000		
PE-0603PFB300ST	30	±25%	100	0.02	5000		
PE-0603PFB260ST	26	±25%	100	0.01	6000		
PE-0805PFB121ST	120	±25%	100	0.03	3000		
PE-0805PFB221ST	220	±25%	100	0.07	2000		
PE-0805PFB331ST	330	±25%	100	0.1	1500		
PE-0805PFB600ST	60	±25%	100	0.025	3000		
PE-1206PFB121ST	120	±25%	100	0.03	3000		
PE-1206PFB500ST	50	±25%	100	0.03	3000		
PE-1206PFB601ST	600	±25%	100	0.1	2000		
PE-1806PFB600ST	60	±25%	100	0.01	6000		
PE-1806PFB720ST	72	±25%	100	0.04	6000		

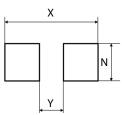
Mechanical

PE-XXXXPFB





PCB LAYOUT



SUGGESTED LAND PATTERN

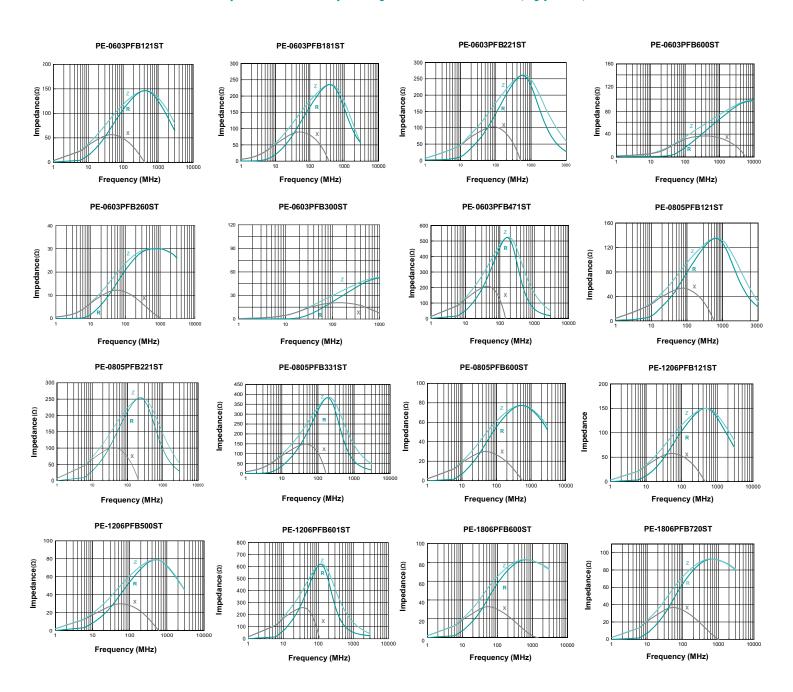
Imperial Size	A	В	W	I	X	Y	Z
0603	1.6±0.15	0.3±0.2	0.8±0.15	0.85±0.2	1.8~2.4	0.6~0.8	0.6~0.8
0805	2.0 (+0.3, -0.1)	0.5±0.3	1.25 ± 0.2	0.85±0.2	2.4~3.6	0.8~1.2	0.9~1.6
1206	3.2±0.2	0.5±0.3	1.6±0.2	0.85±0.2	3.8 ~ 5.5	1.8~2.5	1.2~2.0
1806	4.5±0.2	0.5±0.3	1.6±0.2	1.6±0.2	5.3~6.7	2.4~3.2	0.9~1.6

All units in mm



FERRITE BEAD EMI SUPPRESSOR SINGLE TYPE FOR POWER LINE APPLICATION

Impedance Frequency Characteristics (Typical)



For More Information

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